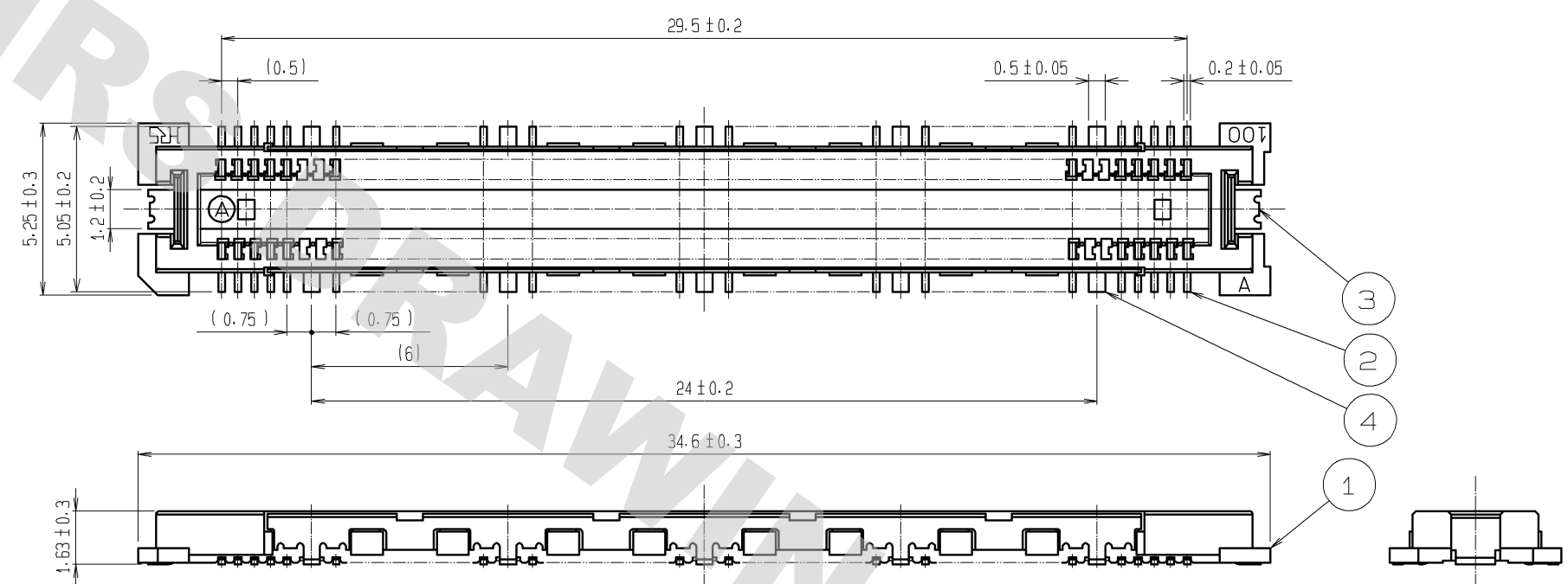
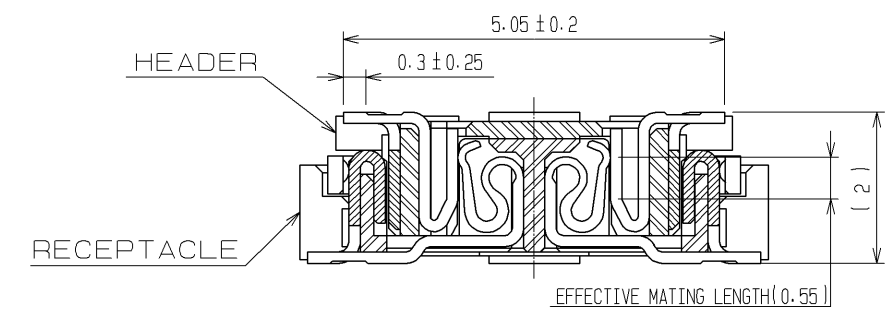


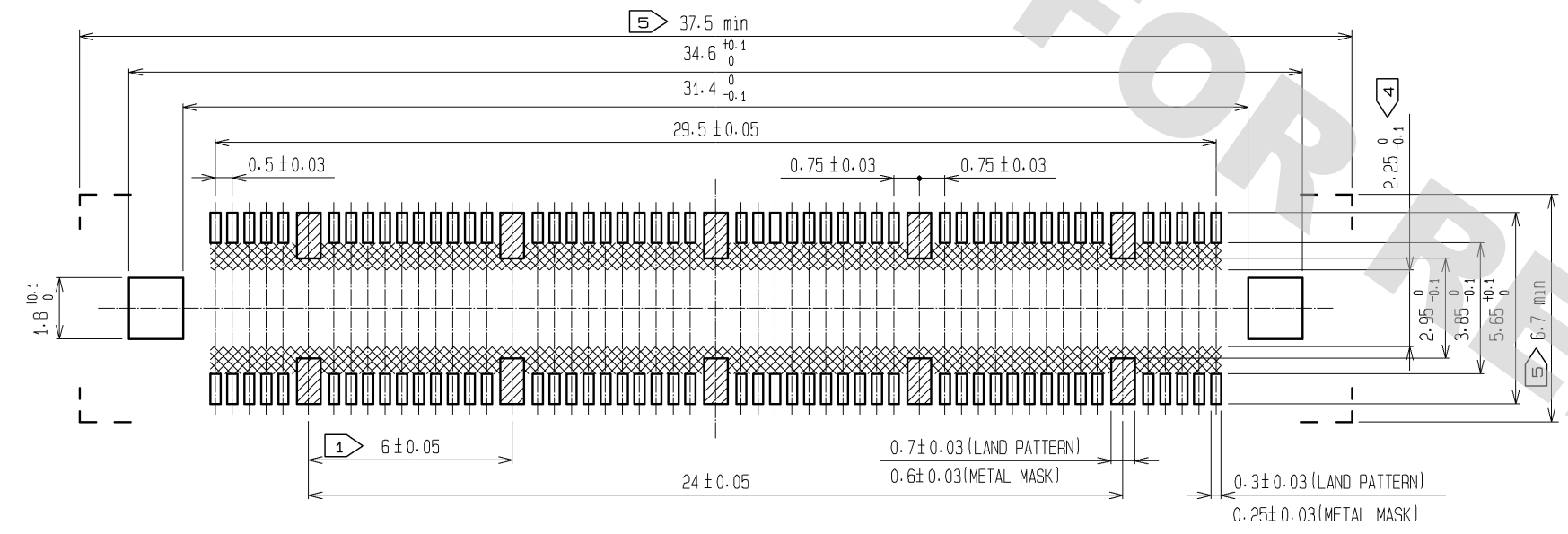
DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012



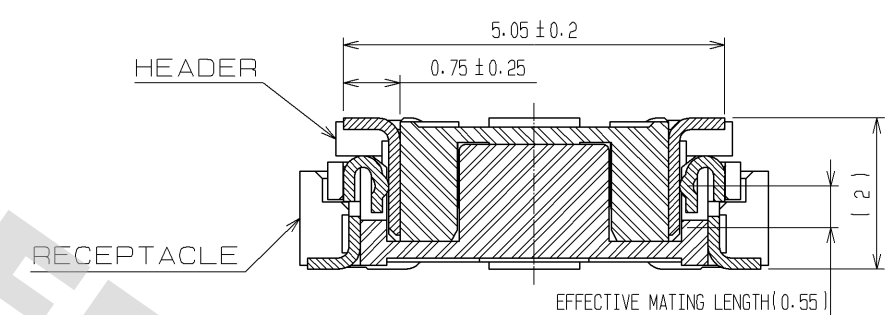
SIGNAL PORTION CROSS SECTION (10:1)



RECOMMENDED LAND PATTERN DIMENSION OF PCB



GROUND PORTION CROSS SECTION (10:1)



- NOTES
- ① 10 HATCHED PARTS: GROUND CIRCUIT.
 - ② SMT LEAD-COPLANARITY: 0.1 MAX.
 - ③ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ④ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑤ DO NOT MOUNT OTHER DEVICES ONTO AREA, OR MATING PAIR CANNOT BE MATED.
 - ⑥ TO BE EMBOSSED CARRIER TAPED AS SPECIFIED IN SHEET 2.
 - ⑦ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

				4	PHOSPHOR BRONZE	TIN PLATING
				3	PHOSPHOR BRONZE	TIN PLATING
				2	COPPER ALLOY	CONTACT AREA : GOLD 0.1μm min.
						LEAD AREA : GOLD FLASH
						UNDER PLATING : NICKEL 1μm min.
1	LCP	BEIGE UL94V-0				
NO.	MATERIAL	FINISH, REMARKS		NO.	MATERIAL	FINISH, REMARKS

UNITS mm		SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE	
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	07.07.26	DRAWING NO.	EDC3-152098-21				
		CHECED : HS. OZAWA	07.07.26	PART NO.	FX11LB-100P/10-SV(91)				
		DESIGNED : SY. KAMIGA	07.07.26	CODE NO.	CL573-0014-6-91				
		DRAWN : HK. SUNADORI	07.07.24	 1/2					

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08/11/2012

